4-bit magnitude comparator Rev. 6 — 21 November 2011

Product data sheet

General description 1.

The HEF4585B is a 4-bit magnitude comparator that compares two 4-bit words, A and B, and determines whether A is greater than B, A is equal to B, or A is less than B. Each word has four parallel inputs (A0 to A3 and B0 to B3) with A3 and B3 being the most significant inputs. Three outputs are provided: A greater than B (QA>B), A less than B (QA<B) and A equal to B (QA=B). Three expander inputs (IA>B, IA<B, and IA=B) allow cascading of the devices, to compare 8, 12, 16, ..., bits without external gates.

To operate a single device or a device in the least significant position in a cascaded chain, the expander inputs are connected as follows: IA=B = IA>B = HIGH and IA<B = LOW. All other cascaded devices have IA=B and IA<B connected to QA=B and QA<B respectively of the previous (less significant) device in the chain, while input IA>B is connected to a HIGH (see Figure 6). Operation is not restricted to pure binary code; the devices will work with any monotonic code. Table 3 describes the operation of the device under all possible logic conditions.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

Ordering information 3.

Table 1. **Ordering information**

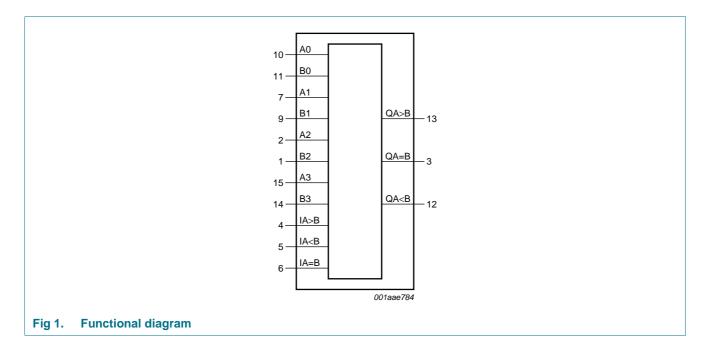
All types operate from -40 °C to +85 °C

Type number	Package	9	
	Name	Description	Version
HEF4585BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
HEF4585BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

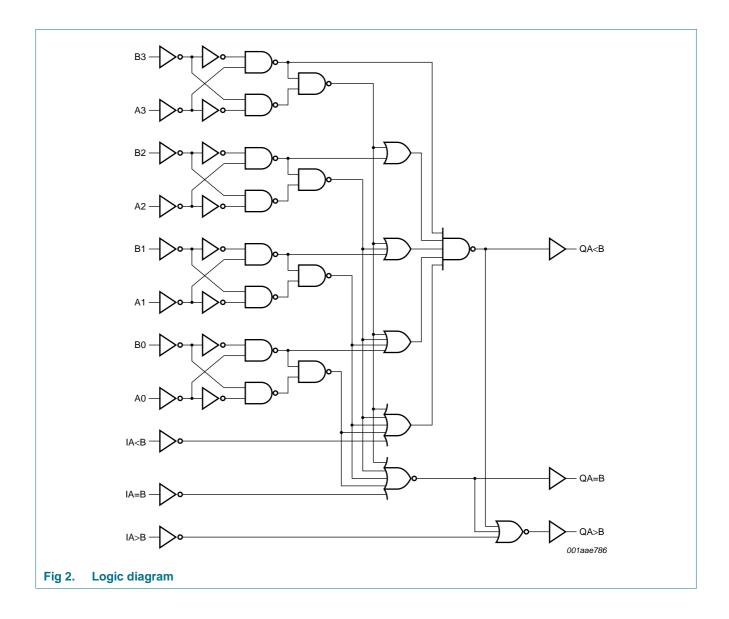


4-bit magnitude comparator

4. Functional diagram



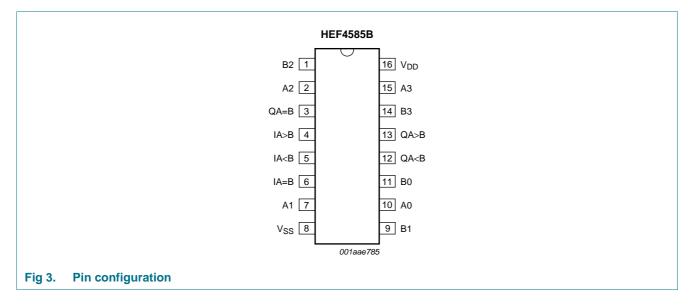
4-bit magnitude comparator



4-bit magnitude comparator

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description		
Symbol		Pin	Description
A[0:3]		10, 7, 2, 15	word A parallel input
B[0:3]		11, 9, 1, 14	word B parallel input
IA>B		4	expander input
IA=B		6	expander input
IA <b< td=""><td></td><td>5</td><td>expander input</td></b<>		5	expander input
QA>B		13	A greater than B output
QA=B		3	A equal to B output
QA <b< td=""><td></td><td>12</td><td>A less than B output</td></b<>		12	A less than B output
V _{DD}		16	supply voltage
V _{SS}		8	ground supply voltage

6. Functional description

Table 3.	Function	selection [1]

Comparin	g inputs			Cascadin	g inputs		Outputs	Outputs	
A3, B3	A2, B2	A1, B1	A0, B0	IA>B	IA <b< th=""><th>IA=B</th><th>QA>B</th><th>QA<b< th=""><th>QA=B</th></b<></th></b<>	IA=B	QA>B	QA <b< th=""><th>QA=B</th></b<>	QA=B
A3 > B3	Х	Х	Х	Н	Х	Х	Н	L	L
A3 < B3	Х	Х	Х	Х	Х	Х	L	Н	L
A3 = B3	A2 > B2	Х	Х	Н	Х	Х	Н	L	L
	A2 < B2	Х	Х	Х	Х	Х	L	Н	L
	A2 = B2	A1 > B1	Х	Н	Х	Х	Н	L	L
		A1 < B1	Х	Х	Х	Х	L	Н	L
		A1 = B1	A0 > B0	Н	Х	Х	Н	L	L
			A0 < B0	Х	Х	Х	L	Н	L
			A0 = B0	Х	L	Н	L	L	Н
				Н	L	L	Н	L	L
				Х	Н	L	L	Н	L
				[2]					
				Х	Н	Н	L	Н	Н
				L	L	L	L	L	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

[2] The first 11 lines describe the normal operation under all conditions that will occur in a single device or in a serial expansion scheme. The last 2 lines describe the operation under abnormal conditions on the cascading inputs. These conditions occur when the parallel expansion technique is used.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	DIP16 package	<u>[1]</u> _	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 $^\circ\text{C}.$

[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

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8. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	−40 °C	T _{amb} =	= 25 °C	T _{amb} =	: 85 °C	Unit
				Min	Max	Min	Max	Min	Max	
VIH	HIGH-level input voltage	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
VIL	LOW-level input voltage	$ I_0 < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{ОН}	HIGH-level output voltage	I _O < 1 μA	5 V	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	V
		15 V	14.95	-	14.95	-	14.95	-	V	
V _{OL}	VoL LOW-level output voltage	I _O < 1 μA	5 V	-	0.05	-	0.05	-	0.05	V
		10 V	-	0.05	-	0.05	-	0.05	V	
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level output current	$V_{O} = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		$V_{O} = 4.6 V$	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mA
I _{OL}	LOW-level output current	$V_O = 0.4 V$	5 V	0.52	-	0.44	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.3	-	1.1	-	0.9	-	mA
		$V_{O} = 1.5 V$	15 V	3.6	-	3.0	-	2.4	-	mA
I	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μA
I _{DD}	supply current	I _O = 0 A	5 V	-	20	-	20	-	150	μA
			10 V	-	40	-	40	-	300	μA
			15 V	-	80	-	80	-	600	μA
CI	input capacitance		-	-	-	-	7.5	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $V_{SS} = 0$ V; $T_{amb} = 25$ °C; for test circuit see <u>Figure 5</u> unless otherwise specified.

				•				
Symbol	Parameter	Conditions ^{[1][2]}	V _{DD}	Extrapolation formula ^[3]	Min	Тур	Max	Unit
t _{PHL}	HIGH to LOW	An, Bn to Qn;	5 V	133 ns + (0.55 ns/pF)C _L	-	160	320	ns
	propagation delay	see <u>Figure 4</u>	10 V	54 ns + (0.23 ns/pF)C _L	-	65	130	ns
			15 V	37 ns + (0.16 ns/pF)C _L	-	45	90	ns
		In to Qn;	5 V	83 ns + (0.55 ns/pF)C _L	-	110	220	ns
		see <u>Figure 4</u>	10 V	34 ns + (0.23 ns/pF)C _L	-	45	90	ns
			15 V	22 ns + (0.16 ns/pF)C _L	-	30	60	ns
t _{PLH}	LOW to HIGH	, , , ,	5 V	123 ns + (0.55 ns/pF)C _L	-	150	300	ns
	propagation delay		10 V	49 ns + (0.23 ns/pF)C _L	-	60	120	ns
			15 V	37 ns + (0.16 ns/pF)C _L	-	45	90	ns
		In to Qn;	5 V	93 ns + (0.55 ns/pF)C _L	-	120	240	ns
		see <u>Figure 4</u>	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	27 ns + (0.16 ns/pF)C _L	-	35	70	ns
t _t	transition time	see <u>Figure 4</u>	5 V	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns

[1] Qn is QA>B, QA<B or QA=B

[2] In is IA>B, IA<B or IA=B

[3] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

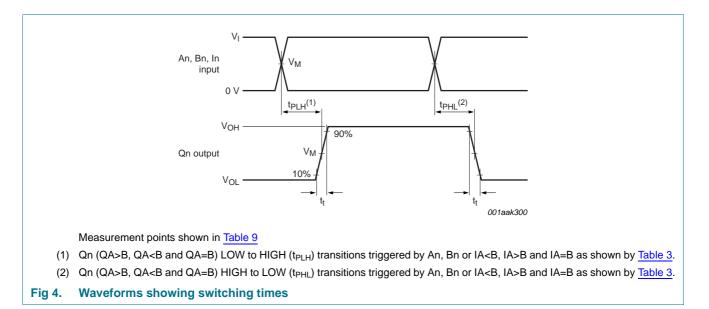
Table 8. Dynamic power dissipation P_D

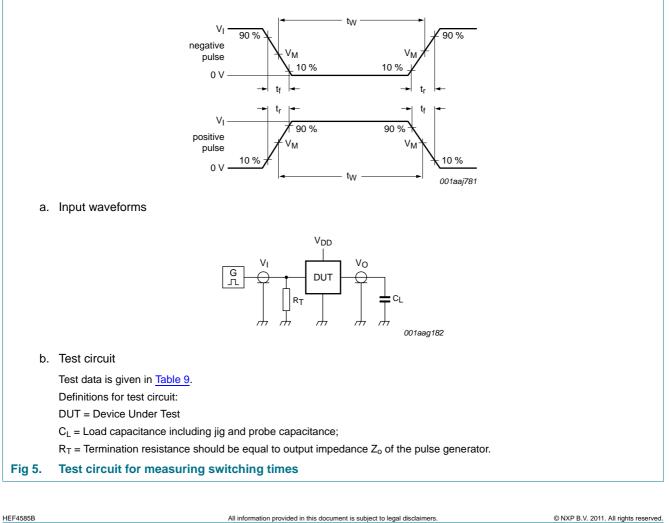
 P_D can be calculated from the formulas shown. $V_{SS} = 0$ V; $C_L = 50$ pF; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	V_{DD}	Typical formula for P_D (μ W)	where:
PD	dynamic power dissipation	5 V	$P_D = 1250 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	$f_i = input frequency in MHz,$
		10 V	$P_D = 5500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	$f_o = output frequency in MHz,$
		15 V	$P_{D} = 15000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	C_L = output load capacitance in pF,
				V_{DD} = supply voltage in V,
				$\Sigma(f_o \times C_L)$ = sum of the outputs.

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11. Waveforms





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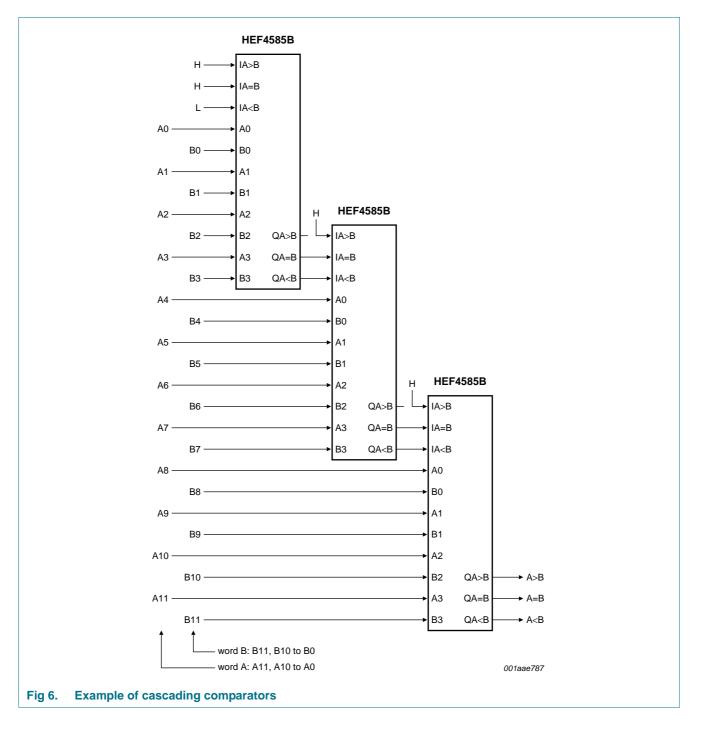
Table 9. Measurement points and test data

Supply voltage	Input	nput			
	VI	V _M	t _r , t _f	CL	
5 V to 15 V	V _{DD}	0.5V _I	\leq 20 ns	50 pF	

12. Application information

Some examples of applications for the HEF4585B are:

- Process controllers
- Servo-motor control



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13. Package outline

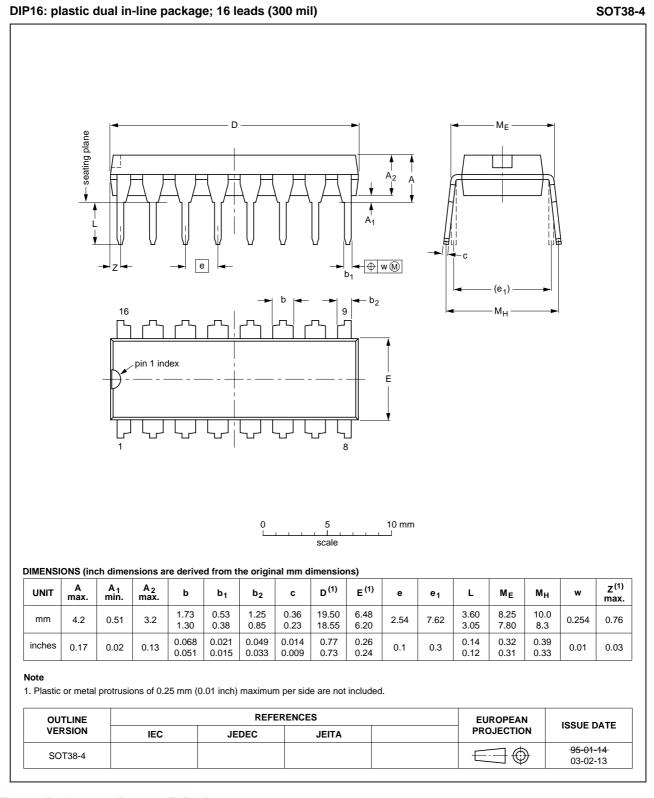


Fig 7. Package outline 38-4 (DIP16)

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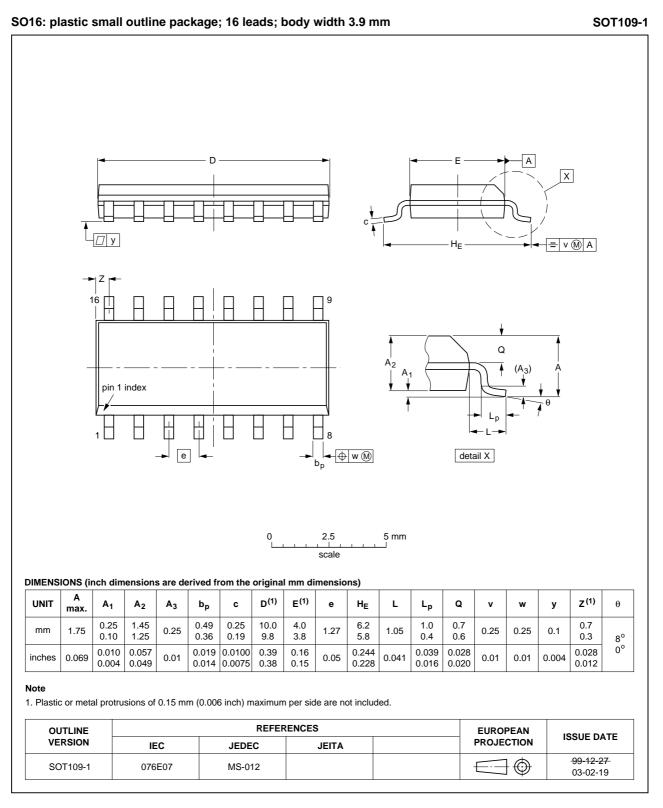


Fig 8. Package outline 109-1 (SO16)

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14. Revision history

Table 10. Revision hi	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4585B v.6	20111121	Product data sheet	-	HEF4585B v.5
Modifications:	 Section Appr 	olications removed		
	• Table 6: I _{OH}	ninimum values changed t	o maximum	
HEF4585B v.5	20091222	Product data sheet	-	HEF4585B v.4
HEF4585B v.4	20090810	Product data sheet	-	HEF4585B_CNV v.3
HEF4585B_CNV v.3	19950101	Product specification	-	HEF4585B_CNV v.2
HEF4585B_CNV v.2	19950101	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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